DSC2A01

Silicon NPN epitaxial planar type

For low frequency amplification

Features

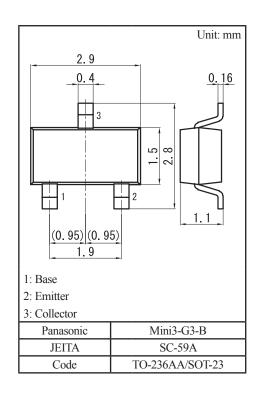
- \bullet High forward current transfer ratio h_{FE} with excellent linearity
- \bullet Low collector-emitter saturation voltage $V_{\text{CE}(\text{sat})}$
- Halogen-free / RoHS compliant (EU RoHS / UL-94 V-0 / MSL: Level 1 compliant)

Marking Symbol: C8

Packaging

DSC2A01×0L Embossed type (Thermo-compression sealing): 3 000 pcs / reel (standard)

Absolute Maximum Ratings $T_a = 25^{\circ}C$ Parameter Symbol Rating Unit Collector-base voltage (Emitter open) V 50 V_{CBO} Collector-emitter voltage (Base open) 40 V VCEO Emitter-base voltage (Collector open) V_{EBO} 15 V Collector current 50 I_{C} mA Peak collector current 100 mА I_{CP} Collector power dissipation P_C 200 mW Junction temperature Tj 150 °C Operating ambient temperature Topr -40 to +85 °C Storage temperature -55 to +150 °C T_{stg}



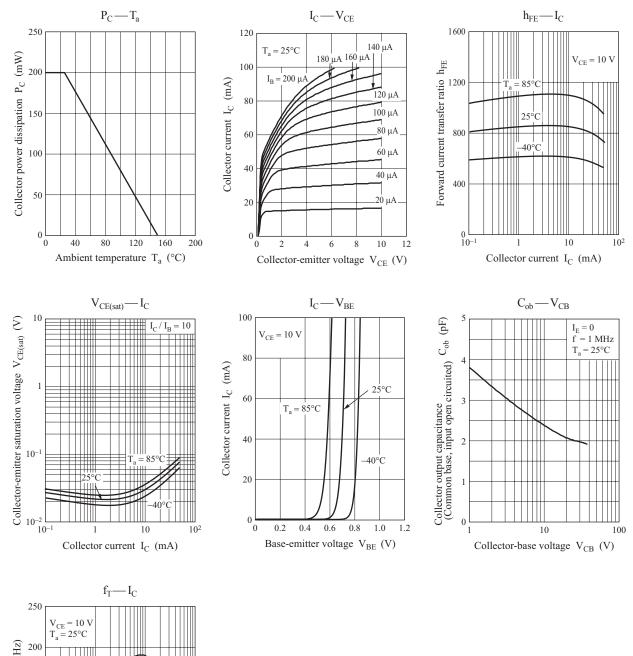
Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

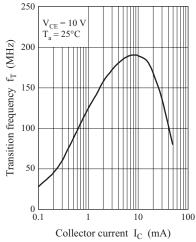
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base voltage (Emitter open)	V _{CBO}	$I_{\rm C} = 10 \ \mu {\rm A}, I_{\rm E} = 0$	50			V
Collector-emitter voltage (Base open)	V _{CEO}	$I_{\rm C} = 1 \text{ mA}, I_{\rm B} = 0$	40			V
Emitter-base voltage (Collector open)	V _{EBO}	$I_{\rm E} = 10 \ \mu A, I_{\rm C} = 0$	15			V
Collector-base cutoff current (Emitter open)	I _{CBO}	$V_{CB} = 20 \text{ V}, I_E = 0$			0.1	μΑ
Collector-emitter cutoff current (Base open)	I _{CEO}	$V_{CE} = 20 \text{ V}, I_{B} = 0$			1	μΑ
Forward current transfer ratio *1	h _{FE}	$V_{CE} = 10 \text{ V}, I_C = 2 \text{ mA}$	400		2000	
Collector-emitter saturation voltage	V _{CE(sat)}	$I_{\rm C} = 10 \text{ mA}, I_{\rm B} = 1 \text{ mA}$		0.05	0.20	V
Transition frequency	f_{T}	$V_{CE} = 10 \text{ V}, I_C = 2 \text{ mA}$		150		MHz

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

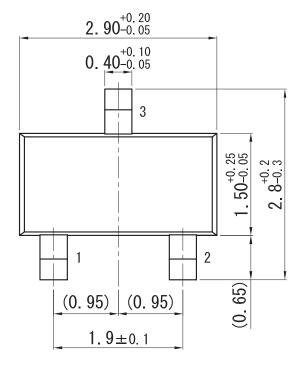
2. *1: Rank classification

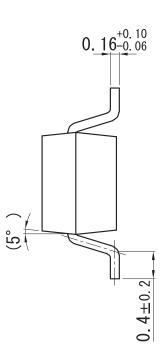
Code	R	S	Т	
Rank	R	S	Т	
$h_{\rm FE}$	400 to 800	600 to 1200	1000 to 2000	
Marking Symbol	C8R	C8S	C8T	

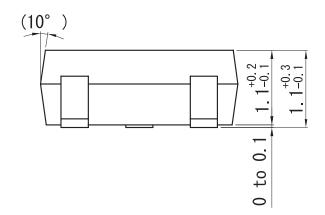




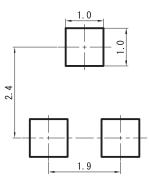
Mini3-G3-B







Land Pattern (Reference) (Unit: mm)



Unit: mm

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